



# Ultra Low VF Schottky Barrier Rectifier 1.0 Amp, 15 Volt

#### **DESCRIPTION**

In Microsemi's Powermite 1 SMT Package, these high efficiency Schottky rectifiers offer power handling capabilities previously found only in much larger packages. They are ideal for SMD applications that operate at high frequencies. In addition to its size advantages, Powermite package features include a full metallic bottom that eliminates the possibility of solder flux entrapment during assembly, and a unique locking tab acts as an integral heat sink. Its innovative design makes this device ideal for use with automatic insertion equipment.

Important: For the latest information, visit our website <a href="http://www.microsemi.com">http://www.microsemi.com</a>.

#### **FEATURES**

- Low profile package (<1.1 mm).</li>
- Small footprint: 10 mm<sup>2</sup> (See mounting pad details on the <u>last page</u>.)
- Ultra low forward voltage provides higher efficiency.
- Low thermal resistance with direct thermal path from the die through integral heat sink and metallic bottom.
- Supplied in 8mm tape and reel.
- RoHS compliant.

#### **APPLICATIONS / BENEFITS**

- High power surface mount package.
- Guard ring construction for transient protection.
- Integral heat sink/locking tabs.
- Compatible with Automatic Insertion Equipment.
- Full-metallic bottom eliminates flux entrapment.
- High surge capacity.
- Ideal for OR'ing diode.

#### MAXIMUM RATINGS

Parameters/Test Conditions	Symbol	Value	Unit
Storage Temperature	T <sub>STG</sub>	-55 to +150	٥C
Junction Temperature	T <sub>J</sub>	-55 to +100	٥C
Thermal Resistance Junction-to-Lead	R <sub>OJL</sub>	15	°C/W
Peak Repetitive Reverse Voltage and also Working Peak Reverse Voltage	V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	15	V
Repetitive Peak Surge Current (1)	I <sub>FSM</sub>	50	Α
Maximum Average DC Output Current  @ Rated V <sub>R</sub> and T <sub>L</sub> = 65 °C	Io	1.0	Α
Voltage Rate of Change @ Rated V <sub>R</sub> and T <sub>J</sub> = 25 °C	dv/dt	1000	V/μs
Max Peak Reverse Current (V <sub>RRM</sub> = 15V, TJ = 25 °C)	I <sub>RM</sub>	10	mA
Solder Temperature @ 10 s	T <sub>SP</sub>	260	°C

**Notes:** 1. Non-Repetitive peak surge current @  $I_O = 1.0$  Amps.





Powermite 1 (DO-216AA) Package

MSC - Lawrence

6 Lake Street, Lawrence, MA 01841 Tel: 1-800-446-1158 or (978) 620-2600

Fax: (978) 689-0803

#### MSC - Ireland

Gort Road Business Park, Ennis, Co. Clare, Ireland Tel: +353 (0) 65 6840044 Fax: +353 (0) 65 6822298

#### Website:

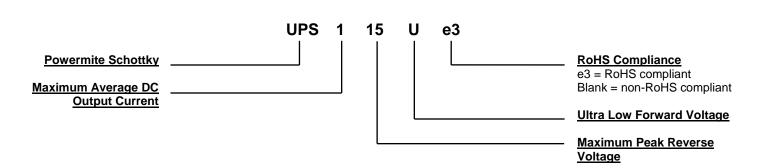
www.microsemi.com



#### **MECHANICAL and PACKAGING**

- CASE: Molded epoxy package meets UL94V-0 at 1/8 inch.
- TERMINALS: Copper with annealed matte-tin plating for RoHS compliance. Solderable per MIL-STD-750 method 2026. (Consult factory for tin-lead plating).
- · MARKING: Body marked with "S15U".
- POLARITY: Cathode designated by Tab 1 (bottom).
- TAPE & REEL option: Packaging per EIA-481-B with 8 mm tape. Consult factory for quantities.
- WEIGHT: Approximately 0.016 grams.
- See <u>Package Dimensions</u> on last page.

#### **PART NOMENCLATURE**



#### **ELECTRICAL CHARACTERISTICS**

RATING (Conditions)	SYMBOL	VALUE	UNIT
Maximum Instantaneous Forward Voltage ( $I_F = 1.0 \text{ Amps}, T_J = +25^{\circ}\text{C}$ )	V <sub>F</sub>	0.31	Volts
Maximum Instantaneous Reverse Current (V <sub>R</sub> = 15 Vdc, T <sub>J</sub> = +25°C)	I <sub>RM</sub>	10	mA
Typical Junction Capacitance (T <sub>J</sub> = 25°C, V <sub>R</sub> = 5V)	Сл	150	pF



#### **GRAPHS**

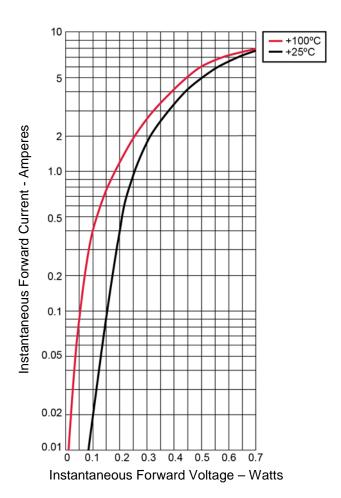


FIGURE 1
Typical Forward Characteristics

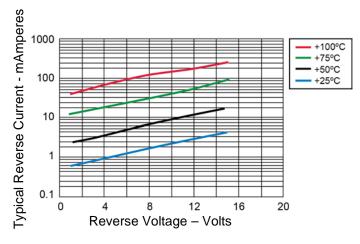


FIGURE 2
Typical Forward Characteristics



### **GRAPHS**

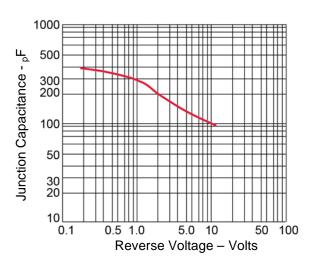
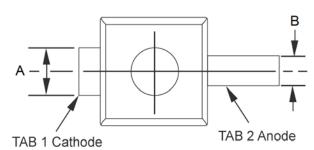
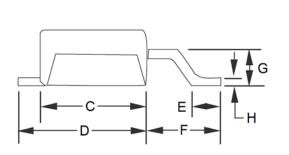


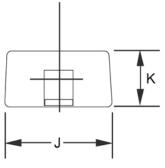
FIGURE 3
Typical Junction Capacitance



#### **PACKAGE DIMENSIONS**

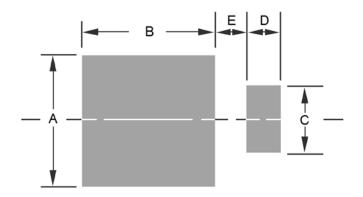






	Dimensions				
Ltr	Ltr Inch		Millimeters		
	Min	Max	Min	Max	
Α	0.029	0.039	0.73	0.99	
В	0.016	0.026	0.40	0.66	
С	0.070	0.080	1.77	2.03	
D	0.087	0.097	2.21	2.46	
Е	0.020	0.030	0.50	0.76	
F	0.051	0.061	1.29	1.54	
G	0.021	0.031	0.53	0.78	
Н	0.004	0.008	0.10	0.20	
J	0.070	0.080	1.77	2.03	
K	0.035	0.045	0.89	1.14	

# PAD LAYOUT



	Dimensions		
Ltr	Inch	Millimeters	
Α	0.100	2.54	
В	0.105	2.67	
С	0.050	1.27	
D	0.030	0.76	
Е	0.025	0.64	

## **SCHEMATIC**



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